# IBIS Chair's Report



http://ibis.org/

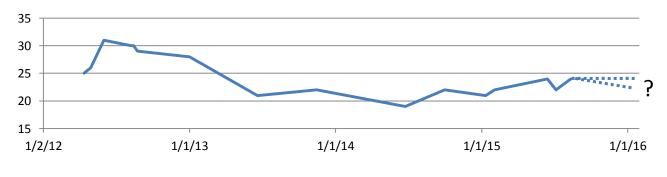
Mike LaBonte SiSoft Chair, IBIS Open Forum

DesignCon IBIS Summit Santa Clara, CA January 22, 2016

## 23-24 IBIS Open Forum Members



#### **Number of Members**



#### **IBIS Officers 2015-2016**

- New Chair, Treasurer and Postmaster elected 15 June 2015
- Many thanks to incumbent IBIS officers for their continued service

A special thank you to outgoing chair Michael Mirmak (Total of 11 terms!)

Chair: Mike LaBonte, Signal Integrity Software

Vice-Chair: Lance Wang, IO Methodology Inc.

Secretary: Randy Wolff, Micron Technology

Treasurer: Bob Ross, Teraspeed Labs

Librarian: Anders Ekholm, Ericsson

Webmaster: Mike LaBonte, Signal Integrity Software

Postmaster: Curtis Clark, ANSYS

## Organizational Status

- IBIS Open Forum: ad-hoc, unincorporated
- SAE Industry Technologies Consortia 501(c)(6)
  - Affiliate of SAE International
  - Fiscal sponsor: receive and disburse funds
  - Legal assistance
  - Liability insurance



- Access to SAE web, publishing support, etc.
- IBIS is one of four ITC clients
- New organization, still in formation process

### **IBIS** Milestones

#### I/O Buffer Information Specification

- 1993-1994 IBIS 1.0-2.1:
  - Behavioral buffer model (fast simulation)
  - Component pin map (easy EDA import)
- 1997-1999 IBIS 3.0-3.2:
  - Package models
  - Electrical Board Description (EBD)
  - Dynamic buffers
- 2002-2006 IBIS 4.0-4.2:
  - Receiver models
  - AMS languages
- 2007-2012 IBIS 5.0-5.1:
  - IBIS-AMI SerDes models
  - Power aware
- 2013-2015 **IBIS 6.0-6.1**:
  - PAM4 multi-level signaling
  - Power delivery package models

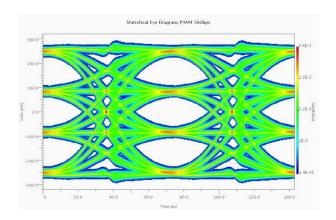
#### Other Work

- 1995: **ANSI/EIA-656** 
  - IBIS 2.1
- 1999: **ANSI/EIA-656-A** 
  - IBIS 3.2
- 2001: IEC 62014-1
  - IBIS 3.2
- 2003: ICM 1.0
  - Interconnect Model Specification
- 2006: ANSI/EIA-656-B
  - IBIS 4.2
- 2009: Touchstone® 2.0\*
- 2011: IBIS-ISS 1.0
  - Interconnect SPICE Subcircuit specification

\*Touchstone® is a registered trademark of Agilent Technologies, Inc.

## Recent Progress: IBIS 6.1 Ratified

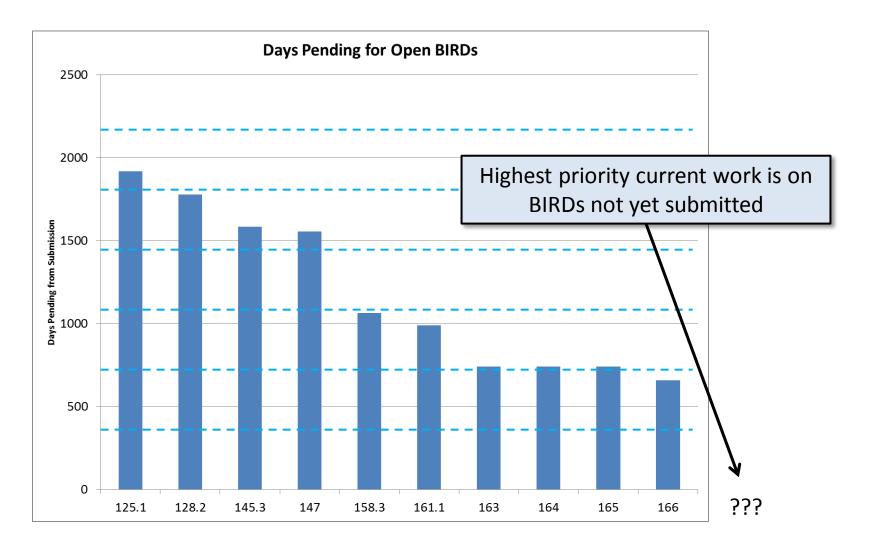
- Ratified 11 September 2015
  - Support for PAM4
  - Dependent IBIS-AMI Parameter Support (AMI\_Resolve)
  - Package Models for Power Integrity
  - and more …
- IBISCHK 6.1.2 available



### In The Works

- Advanced Technology Modeling Task Group
  - Reference node clarifications (IBIS 6.2)
  - Optimization/Back-channel support
  - External circuit enhancements
- Interconnect Task Group
  - External Package/on-die models using IBIS-ISS
- IBIS Quality Task Group
  - IBISCHK enhancements and documentation

# Pending BIRDs

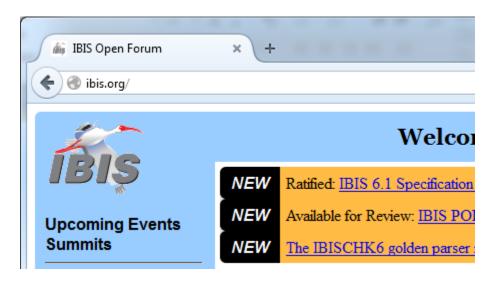


### Workflow Enhancement Ideas

- Automatic BIRD expiration?
  - Pressure to keep momentum
- More task groups?
  - Increased "parallelism"
- Break up the BIRD?
  - 1. BIDD: Buffer Issue Definition Document
    - Settle problem definition and solution requirements first
    - For enhancements, not required for fix and clarification BIRDs
  - 2. Solutions are proposed and discussed
    - Refer to BIDD number
  - One or more BIRDs submitted against BIDD
- ...?

#### We Have Moved!

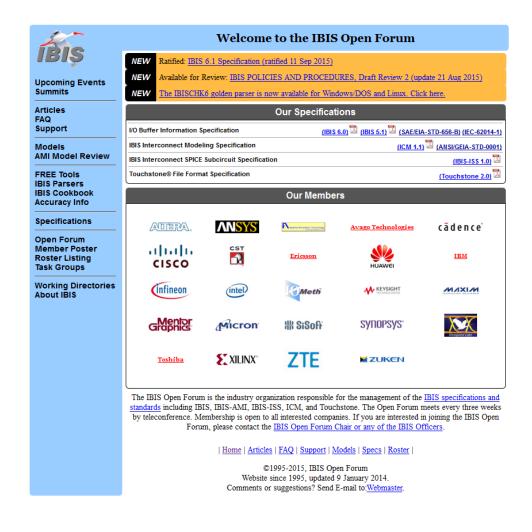
- Our gratitude to Accellera for eda.org web and email service from 1993 to 2015
- Email lists have moved to freelists.org
- Website has moved to http://ibis.org



### Same Website For Now

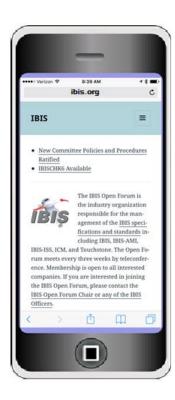
- Manually edited HTML
- Server shell login required
- Not great on phones

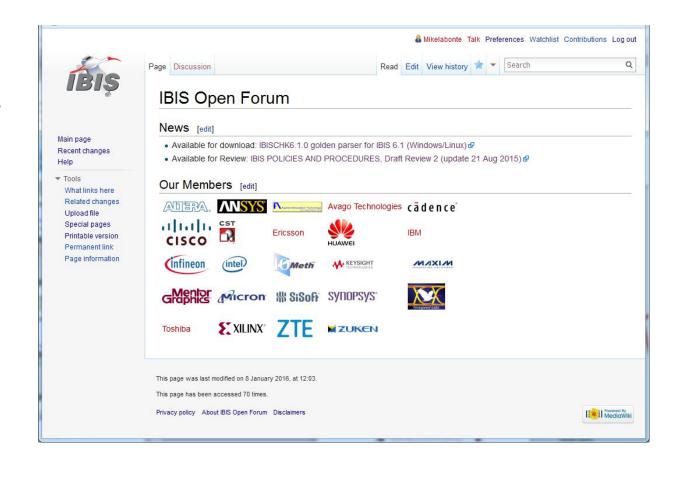




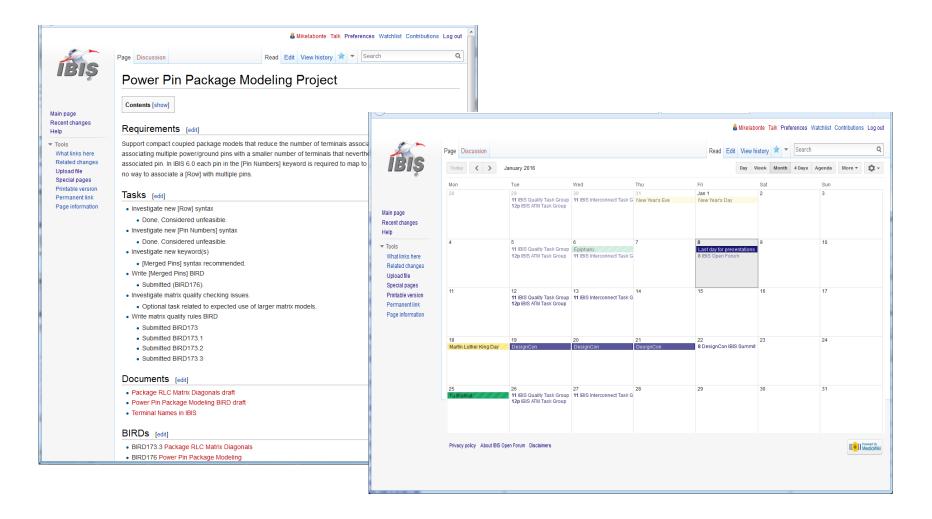
### New Website In The Works

- MediaWiki
- Searchable
- Multi-User
- Adapts to phones





### Interactive Multi-User Website



# [Thank You]



IBIS Open Forum:

Web: <a href="http://ibis.org">http://ibis.org</a>

Email: <a href="mailto:ibis-info@freelists.org">ibis-info@freelists.org</a>

We welcome participation by all IBIS model makers, EDA tool vendors, IBIS model users, and interested parties.